DISCRETE SEMICONDUCTORS

DATA SHEET

PDTC124X series NPN resistor-equipped transistors; R1 = 22 k Ω , R2 = 47 k Ω

Product specification Supersedes data of 2003 Apr 10 2004 Aug 13





PDTC124X series

FEATURES

- Built-in bias resistors
- · Simplified circuit design
- Reduction of component count
- Reduced pick and place costs.

APPLICATIONS

- · General purpose switching and amplification
- · Inverter and interface circuits
- · Circuit driver.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	TYP.	MAX.	UNIT
V _{CEO}	collector-emitter voltage	_	50	V
Io	output current (DC)	_	100	mA
R1	bias resistor	22	_	kΩ
R2	bias resistor	47	_	kΩ

DESCRIPTION

NPN resistor-equipped transistor (see "Simplified outline, symbol and pinning" for package details).

PRODUCT OVERVIEW

TYPE NUMBER	PAC	KAGE	MARKING CODE	DND COMPLEMENT
I TPE NUMBER	PHILIPS	EIAJ	MARKING CODE	PNP COMPLEMENT
PDTC124XE	SOT416	SC-75	32	PDTA124XE
PDTC124XEF	SOT490	SC-89	32	PDTA124XEF
PDTC124XK	SOT346	SC-59	51	PDTA124XK
PDTC124XM	SOT883	SC-101	DZ	PDTA124XM
PDTC124XS	SOT54 (TO-92)	SC-43	TC124X	PDTA124XS
PDTC124XT	SOT23	_	*46 ⁽¹⁾	PDTA124XT
PDTC124XU	SOT323	SC-70	*51 ⁽¹⁾	PDTA124XU

Note

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^{1. * =} p: Made in Hong Kong.

^{* =} t: Made in Malaysia.

^{* =} W: Made in China.

NPN resistor-equipped transistors; R1 = 22 k Ω , R2 = 47 k Ω

PDTC124X series

SIMPLIFIED OUTLINE, SYMBOL AND PINNING

TYPE NUMBER	CIMPLIFIED OUTLINE AND CYMPOL		PINNING
TYPE NUMBER	SIMPLIFIED OUTLINE AND SYMBOL	PIN	DESCRIPTION
PDTC124XS		1	base
		2	collector
	R1 R1 R2 R2 R2 R2 R2	3	emitter
PDTC124XE PDTC124XEF PDTC124XK PDTC124XT PDTC124XU	Top view 1 R1 R2 2 MDB269	1 2 3	base emitter collector
PDTC124XM	2 R1 R2 2 bottom view MHC506	1 2 3	base emitter collector

NPN resistor-equipped transistors; R1 = 22 k Ω , R2 = 47 k Ω

PDTC124X series

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{CBO}	collector-base voltage	open emitter	_	50	V
V _{CEO}	collector-emitter voltage	open base	_	50	V
V _{EBO}	emitter-base voltage	open collector	_	10	V
V _I	input voltage				
	positive		_	+40	V
	negative		_	-7	V
Io	output current (DC)		_	100	mA
I _{CM}	peak collector current		_	100	mA
P _{tot}	total power dissipation	T _{amb} ≤ 25 °C			
	SOT54	note 1	_	500	mW
	SOT23	note 1	_	250	mW
	SOT346	note 1	_	250	mW
	SOT323	note 1	_	200	mW
	SOT416	note 1	_	150	mW
	SOT490	notes 1 and 2	_	250	mW
	SOT883	notes 2 and 3	_	250	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		_	150	°C
T _{amb}	operating ambient temperature		-65	+150	°C

Notes

- 1. Refer to standard mounting conditions.
- 2. Reflow soldering is the only recommended soldering method.
- 3. Refer to SOT883 standard mounting conditions; FR4 with 60 μm copper strip line.

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-a}	thermal resistance from junction to ambient	in free air		
	SOT54	note 1	250	K/W
	SOT23	note 1	500	K/W
	SOT346	note 1	500	K/W
	SOT323	note 1	625	K/W
	SOT416	note 1	833	K/W
	SOT490	notes 1 and 2	500	K/W
	SOT883	notes 2 and 3	500	K/W

Notes

- 1. Refer to standard mounting conditions.
- 2. Reflow soldering is the only recommended soldering method.
- 3. Refer to SOT883 standard mounting conditions; FR4 with 60 μ m copper strip line.

NPN resistor-equipped transistors; R1 = 22 k Ω , R2 = 47 k Ω

PDTC124X series

CHARACTERISTICS

 T_{amb} = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
I _{CBO}	collector-base cut-off current	V _{CB} = 50 V; I _E = 0	_	_	100	nA
I _{CEO}	collector-emitter cut-off current	$V_{CE} = 30 \text{ V}; I_{B} = 0$	_	_	1	μΑ
		V _{CE} = 30 V; I _B = 0; T _j = 150 °C	_	_	50	μΑ
I _{EBO}	emitter-base cut-off current	V _{EB} = 5 V; I _C = 0	_	_	120	μΑ
h _{FE}	DC current gain	V _{CE} = 5 V; I _C = 5 mA	80	_	_	
V _{CEsat}	collector-emitter saturation voltage I _C = 10 mA; I _B = 0.5 mA		_	_	150	mV
$V_{i(off)}$	input-off voltage	$I_C = 100 \mu\text{A}; V_{CE} = 5 \text{V}$	_	0.8	0.5	V
V _{i(on)}	input-on voltage	$I_C = 2 \text{ mA}; V_{CE} = 0.3 \text{ V}$	2	1.1	_	V
R1	input resistor		15.4	22	28.6	kΩ
R2 R1	resistor ratio		1.7	2.1	2.6	
C _c	collector capacitance	I _E = i _e = 0; V _{CB} = 10 V; f = 1 MHz	_	_	2.5	pF

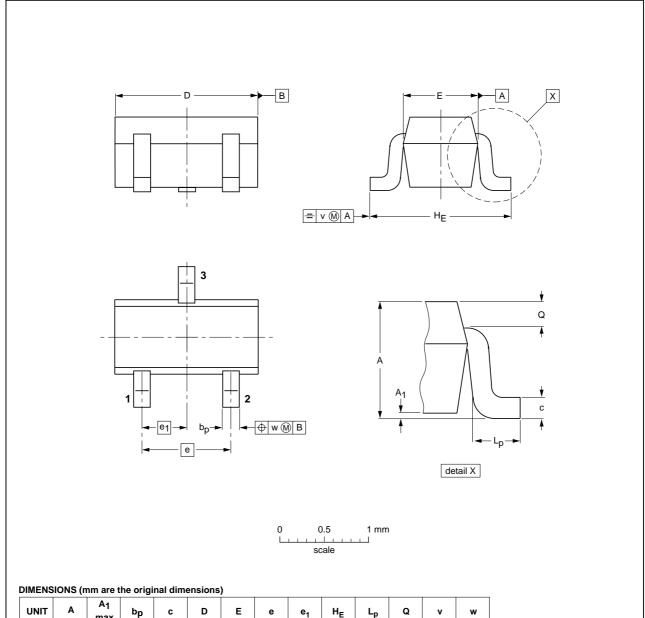
NPN resistor-equipped transistors; R1 = 22 k Ω , R2 = 47 k Ω

PDTC124X series

PACKAGE OUTLINES

Plastic surface mounted package; 3 leads

SOT416



UNIT	А	A ₁ max	bp	С	D	Е	e	e ₁	HE	Lp	Q	v	w
mm	0.95 0.60	0.1	0.30 0.15	0.25 0.10	1.8 1.4	0.9 0.7	1	0.5	1.75 1.45	0.45 0.15	0.23 0.13	0.2	0.2

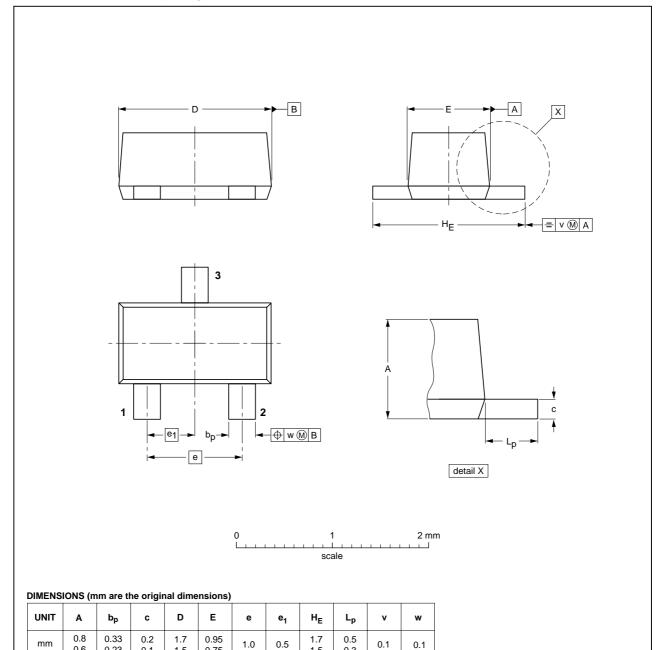
OUTLINE		REFER	EUROPEAN	ICCUIT DATE		
VERSION	IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE	
SOT416			SC-75		97-02-28	

NPN resistor-equipped transistors; $R1 = 22 \text{ k}\Omega$, $R2 = 47 \text{ k}\Omega$

PDTC124X series

Plastic surface mounted package; 3 leads

SOT490



OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ	PROJECTION	1550E DATE	
SOT490			SC-89		98-10-23	

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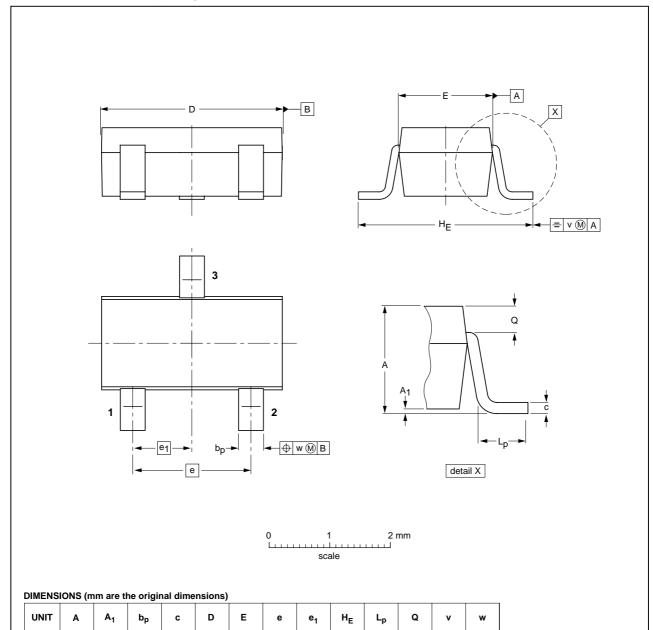
0.6

0.23

PDTC124X series

Plastic surface mounted package; 3 leads

SOT346



	OUTLINE VERSION		REFER	EUROPEAN	ISSUE DATE	
		IEC	JEDEC	EIAJ	PROJECTION	ISSUE DATE
	SOT346		TO-236	SC-59		98-07-17

0.95

1.9

0.33

0.2

0.2

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1.3

1.0

0.1

0.013

0.50

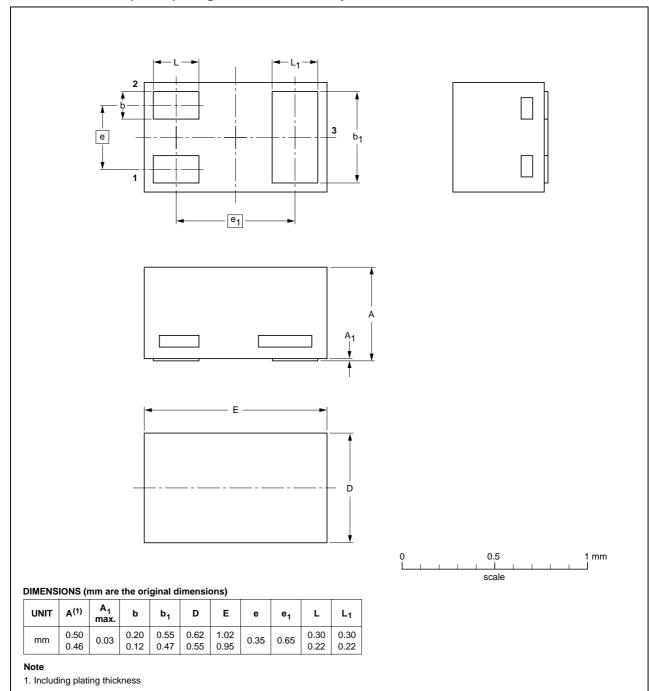
0.35

NPN resistor-equipped transistors; R1 = 22 k Ω , R2 = 47 k Ω

PDTC124X series

Leadless ultra small plastic package; 3 solder lands; body 1.0 x 0.6 x 0.5 mm

SOT883



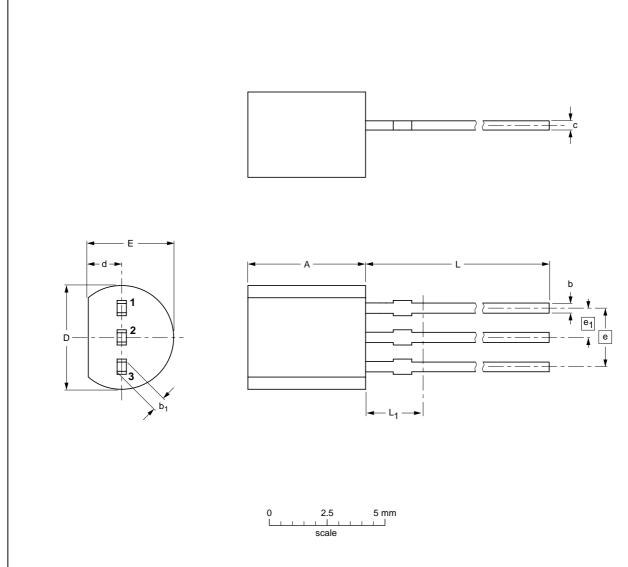
OUTLINE VERSION		REFER	EUROPEAN	ISSUE DATE	
	IEC	JEDEC	JEITA	PROJECTION	1330E DATE
SOT883			SC-101		03-02-05 03-04-03

NPN resistor-equipped transistors; R1 = 22 k Ω , R2 = 47 k Ω

PDTC124X series

Plastic single-ended leaded (through hole) package; 3 leads

SOT54



DIMENSIONS (mm are the original dimensions)

UNIT	A	b	b ₁	С	D	d	E	е	e ₁	L	L ₁ ⁽¹⁾ max.	
mm	5.2 5.0	0.48 0.40	0.66 0.55	0.45 0.38	4.8 4.4	1.7 1.4	4.2 3.6	2.54	1.27	14.5 12.7	2.5	

Note

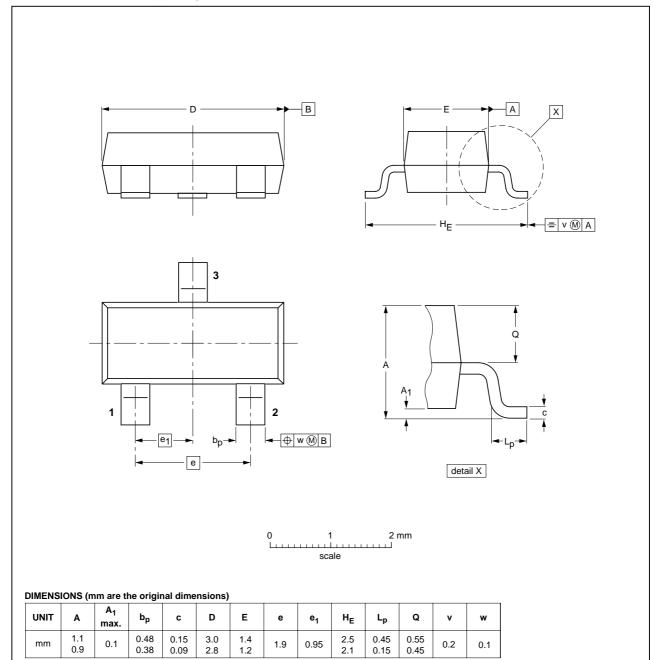
1. Terminal dimensions within this zone are uncontrolled to allow for flow of plastic and terminal irregularities.

OUTLINE	REFERENCES				EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	JEITA		PROJECTION	ISSUE DATE
SOT54		TO-92	SC-43A			97-02-28 04-06-28

PDTC124X series

Plastic surface mounted package; 3 leads

SOT23

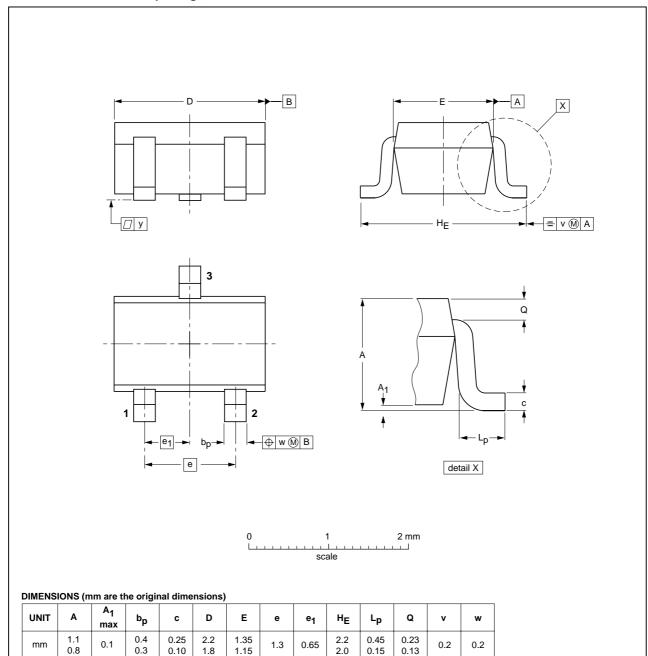


OUTLINE	REFERENCES				EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT23		TO-236AB				-97-02-28 99-09-13

PDTC124X series

Plastic surface mounted package; 3 leads

SOT323



OUTLINE	REFERENCES				EUROPEAN	ISSUE DATE
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT323			SC-70			97-02-28

NPN resistor-equipped transistors; R1 = 22 k Ω , R2 = 47 k Ω

PDTC124X series

DATA SHEET STATUS

LEVEL	DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS(2)(3)	DEFINITION
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- 3. For data sheets describing multiple type numbers, the highest-level product status determines the data sheet status.

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Limiting values definition — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

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